

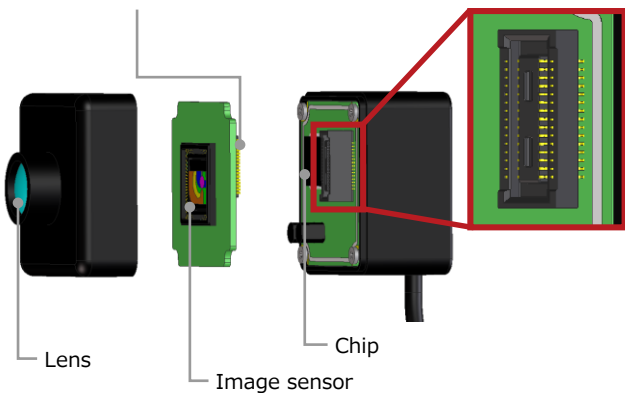
Features

- 1 125°C heat resistance for automotive specifications
- 2 0.4mm pitch, 3.38mm depth, small FPC to board connector
- 3 Wide position and height varieties
- 4 PCI Express 4.0 (16Gbps) compliant
- 5 Optimized contact design and material for high heat resistance

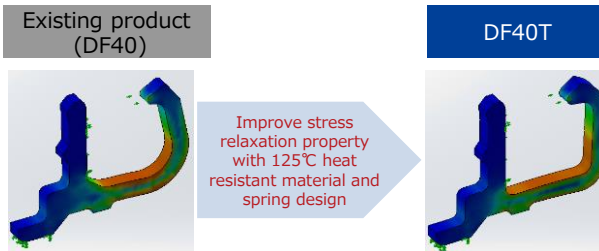
Board to Board connection in automotive camera

Header:  
DF40TC-30DP-0.4V

Receptacle:  
DF40TC(3.5)-30DS-0.4V



125°C heat resistant contact



Heat resistant/temperature cycle test result

125°C/2000h		[mΩ] -55~125°C/2000 cycle		[mΩ]	
	Initial	After test		Initial	After test
AVG	18.67	20.82	AVG	17.67	17.30

Specifications

Rated current	0.3A
Rated voltage	30V AC
Operating temperature	-55 to +125°C*
Contact resistance	90mΩ Max. (100mA DC or 1000Hz)
Withstanding voltage	100V AC for 1 minute
Insulation resistance	50MΩ min. (100V DC)

\* Include the temperature rising by current flow.